

CoolSiC™ – The perfect solution for servo drives

Infineon's comprehensive portfolio for industrial drives applications

December 2020



Agenda

- 1 Application requirements
- 2 System level benefits
- 3 Case study of IGBTs and CoolSiC™ MOSFETs for industrial drives
- 4 Auxiliary power supply
- 5 CoolSiC™ MOSFET evaluation boards
- 6 Industrial CoolSiC™ portfolio
- 7 Key takeaways

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Case study of IGBTs and CoolSiC™ MOSFETs for industrial drives

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Industrial CoolSiC™ portfolio

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Key takeaways

Specific drives applications and motor types in the industry



Industrial Drives

- › Low voltage drives
 - › General purpose drives
 - › Servo drives
 - › C-HVAC
- › Medium voltage drives



Industrial motor types

- › Induction motor
- › Switched reluctance motor
- › Permanent magnet synchronous motor
- › Servo motor
- › Brushed DC motor
- › Brushless DC motor



Industrial automation

- › Industrial automation

Overview of three major areas in low voltage drives

General purpose drives

370 W

1250 kW

Requirements

- > Performance and reliability
- > Safety features
- > Good price / performance ratio

Key applications

- > Pumps & fans
- > Process automation
- > Cranes
- > Marine drives

Infinion products

- | | |
|---------------------------|--------------------|
| > iMOTION™ | > EconoPIM™ |
| > CIPOS™ IPM | > EconoDUAL™ |
| > EiceDRIVER™ gate driver | > PrimePACK™ |
| > EasyPIM™ | > CoolSiC™ MOSFETs |

Servo drives

370 W

315 kW

Requirements

- > High positioning accuracy
- > Fast response with no overshoot
- > High reliability

Key applications

- > Robotics
- > Material handling
- > Machine tools

Infinion products

- | | |
|---------------------------|--------------------|
| > CIPOS™ IPM | > EasyPACK™ |
| > Discretes | > EconoDUAL™ |
| > EiceDRIVER™ gate driver | > CoolSiC™ MOSFETs |
| > EconoPACK™ | |

C-HVAC

3 kW

75 kW

Requirements

- > Good price / performance ratio

Key applications

- > Commercial Heating & Ventilation Air-Conditioning (C-HVAC)

Infinion products

- > EconoPIM™
- > EasyPIM™
- > EiceDRIVER™ gate driver
- > CIPOS™ IPM
- > iMOTION™

Overview of medium voltage drives

Medium voltage drives

250 kW

36 MW

Requirements

- > Long life cycle
- > Fast repair
- > Redundancy
- > High efficiency

Key applications

- > Water pumps
- > Material handling
- > Power generation
- > Oil & gas

Infineon products

- > PrimePACK™
- > PrimePACK™ .XT
- > XHP™ 2
- > XHP™ 3
- > EconoDUAL™
- > 62mm
- > EiceDRIVER™ gate driver



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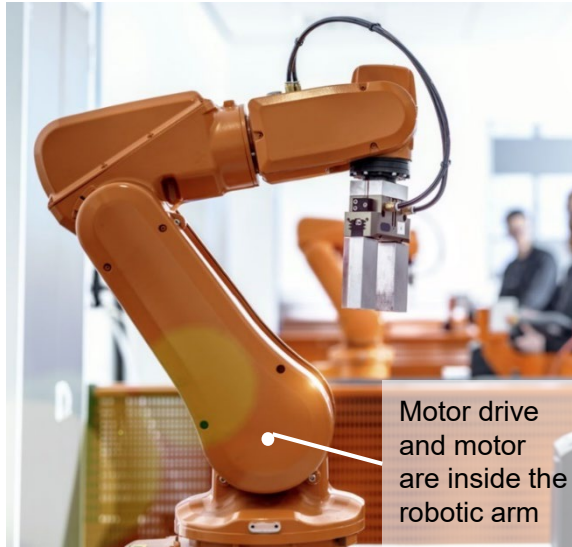
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Industrial CoolSiC™ portfolio

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Key takeaways

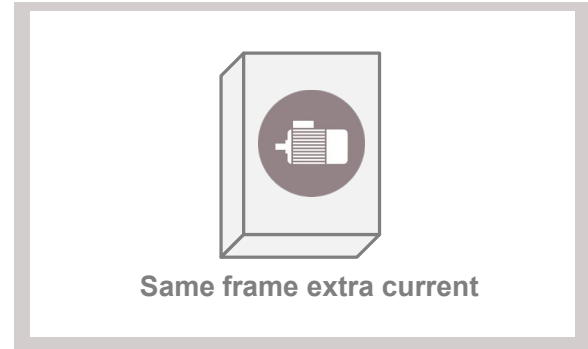
CoolSiC™ MOSFET - next generation of servo drives



Enhance pulse current capability



Current rating jump



Passive cooling



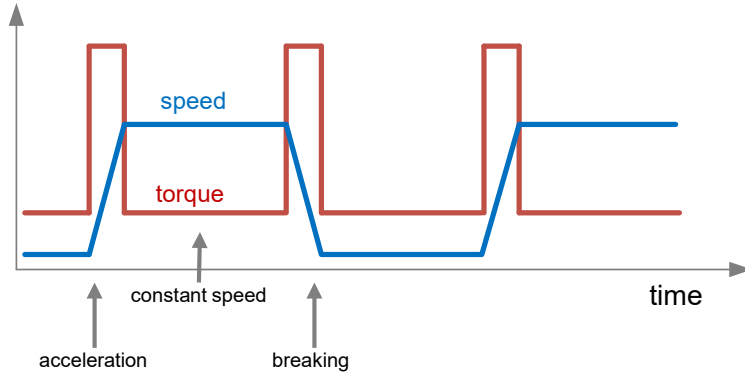
Inverter motor integration



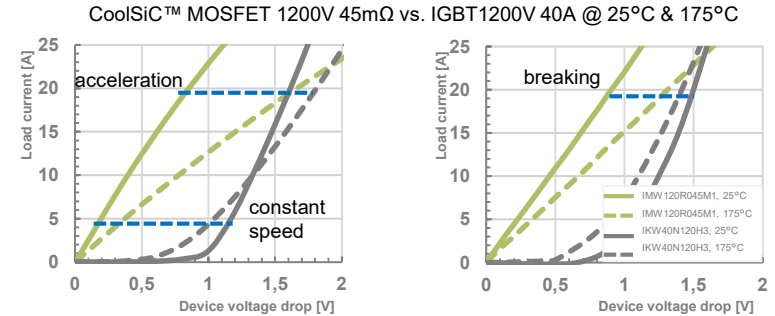
CoolSiC™ MOSFET in servo drives: conduction loss reduction in all operation modes

Typical load profile for a servo drive

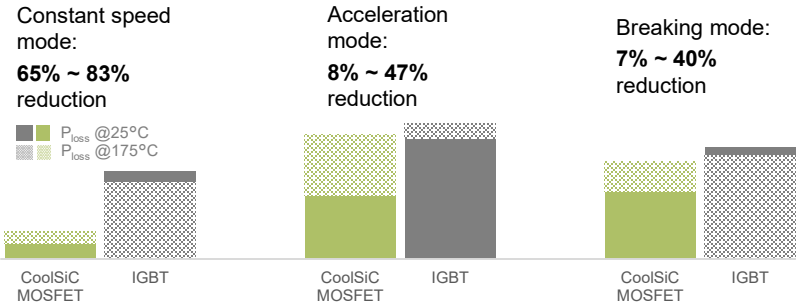
- > High torque (current) in acceleration and braking period
- > Low torque (current) in constant speed period
- > >90% time in low torque operation



Output characteristic comparison



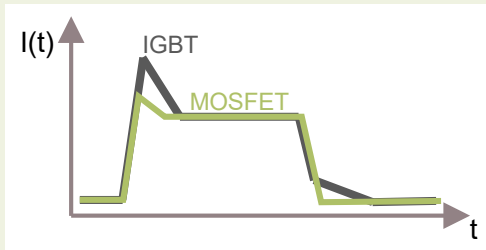
CoolSiC™ MOSFET reduces conduction loss in all operation modes



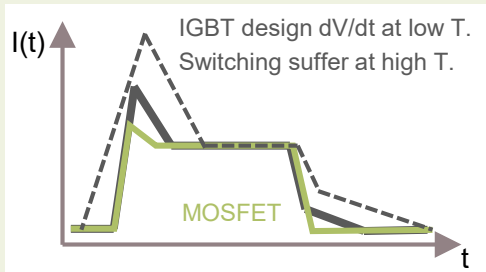
CoolSiC™ MOSFET in servo drives: switching loss reduction

Switching loss reduction by using CoolSiC™ MOSFET even at the same EMC level

- › Low Q_{rr} and No tail current

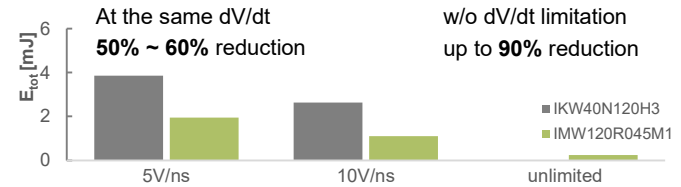


- › Temperature independent switching losses

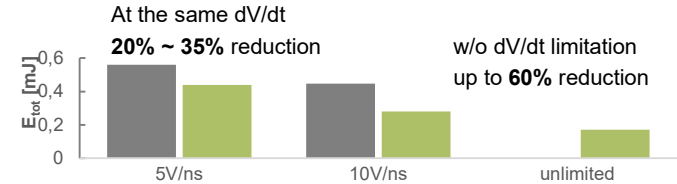


CoolSiC™ MOSFET reduces switching loss in all operation modes

Total switching loss at 150°C, acceleration and braking (20 A)



Total switching loss at 25°C, constant speed operation (5 A)



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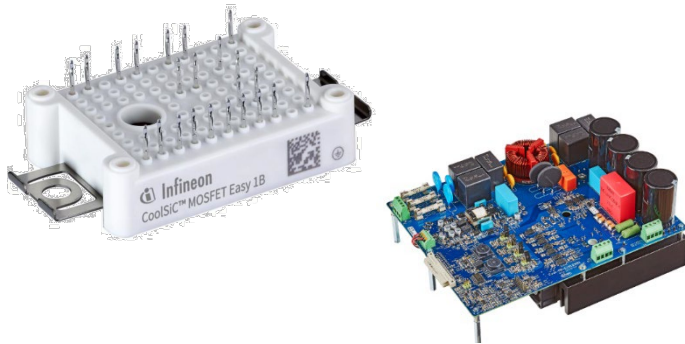
Industrial CoolSiC™ portfolio

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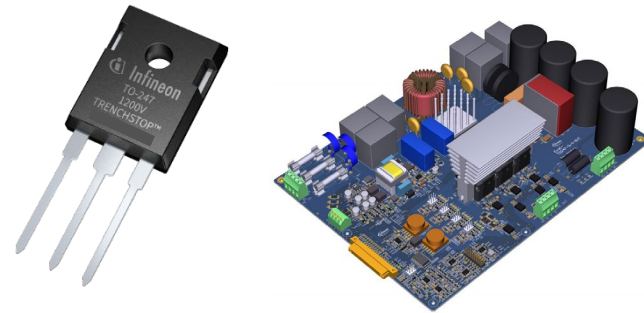
Key takeaways

Case study of IGBTs and CoolSiC™ MOSFETs for industrial drives

- › Easy module
 - TRENCHSTOP™ IGBT4
 - TRENCHSTOP™ IGBT7
 - CoolSiC™ MOSFET
- › dv/dt selection
- › Switching losses
- › Application simulation



- › Discrete device – TO247
 - HighSpeed 3 IGBT
 - CoolSiC™ MOSFET
- › dv/dt selection
- › Switching losses
- › Application simulation
- › Application measurement



Case study: Easy package laboratory test configuration

IGBT4



FS25R12W2T4

IGBT7

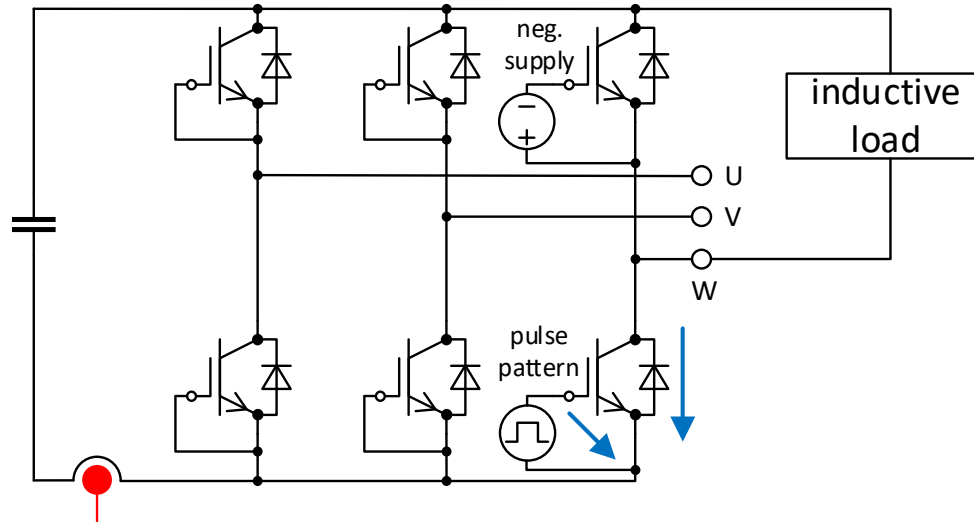


FP25R12W2T7

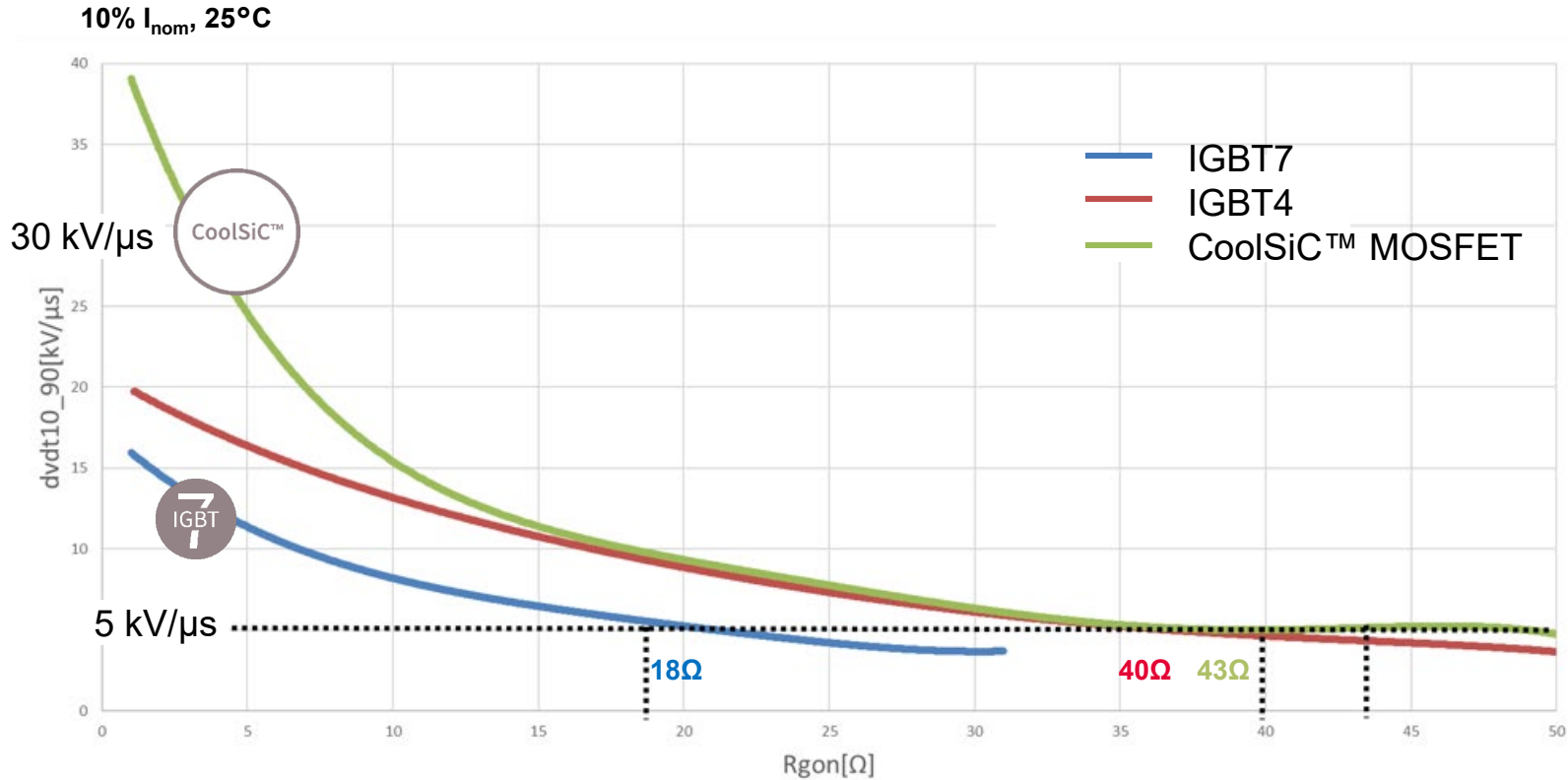
CoolSiC™



FS45MR12W1M1

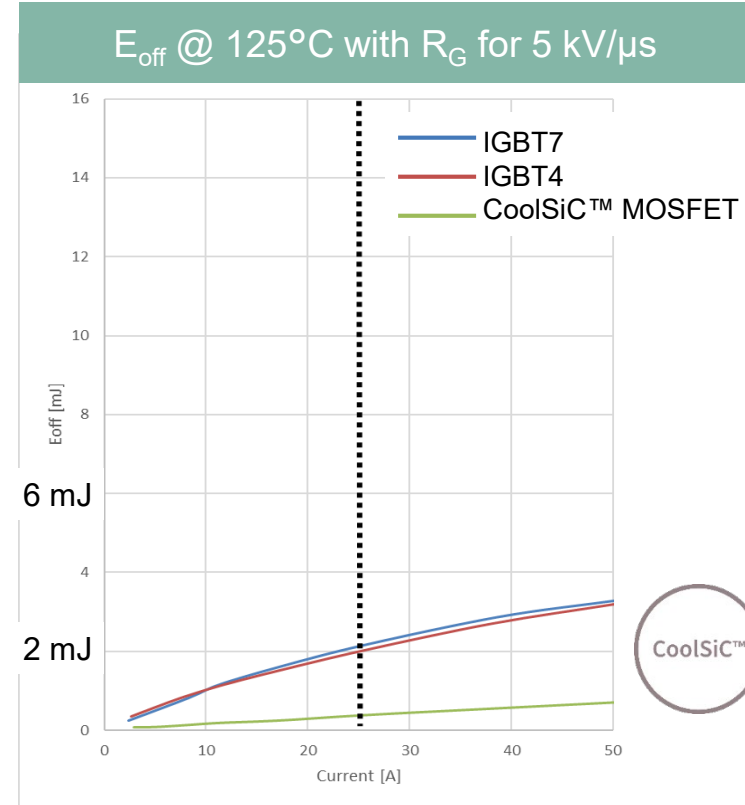
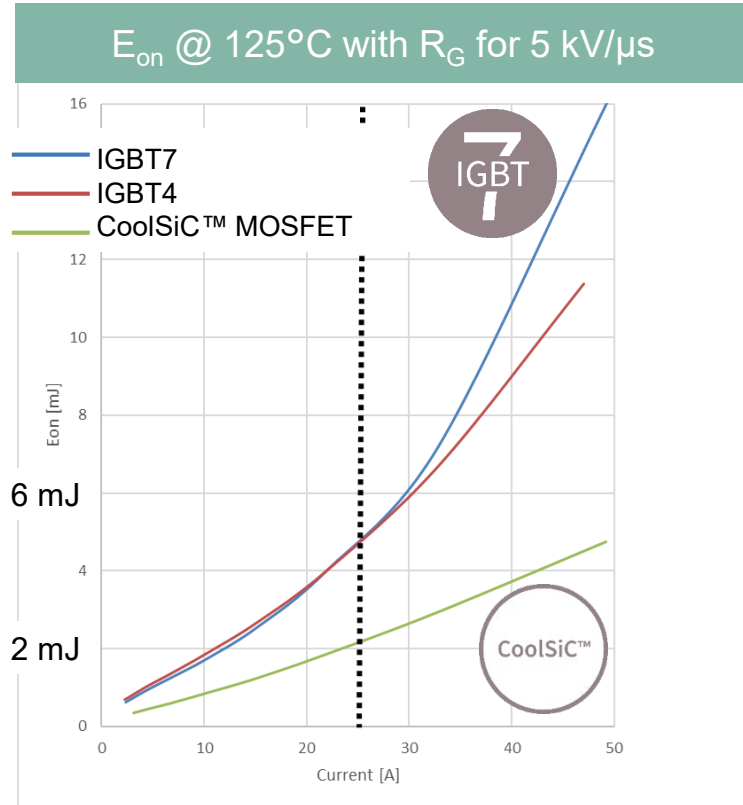


Case study: Easy package defining the gate resistance



100% I_{nom} , 25°C → Worst case for turn off → Usually the off gate resistance can be smaller for 5 kV/μs

Case study: Easy package switching losses at R_G for 5 kV/ μ s

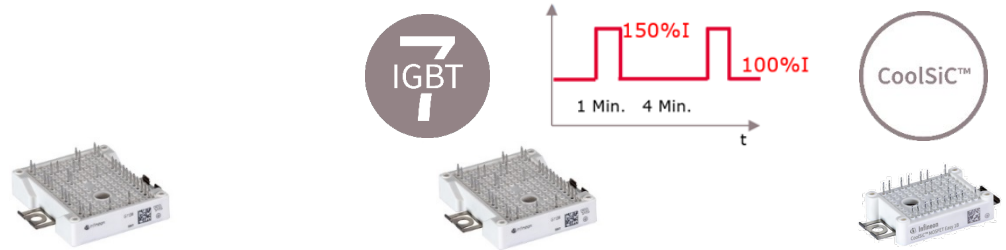


*Note that these graphs might not be 100% compatible with the following slides, due to systematic/random errors in measurement. Different dates/modules

Case study: Easy package input parameters

- > $V_{DC} = 600 \text{ V}$
- > $f_{out} = 50 \text{ Hz}$
- > $dv/dt_{1090} = 5 \text{ kV}/\mu\text{s}$
- > $f_{SW} = 3 \text{ kHz}$ (6 kHz SiC)
- > $m_i = 1$
- > $\cos \varphi = 1$
- > $T_A = 50^\circ\text{C}$
- > $\tau_{thHA} = 60 \text{ s}$

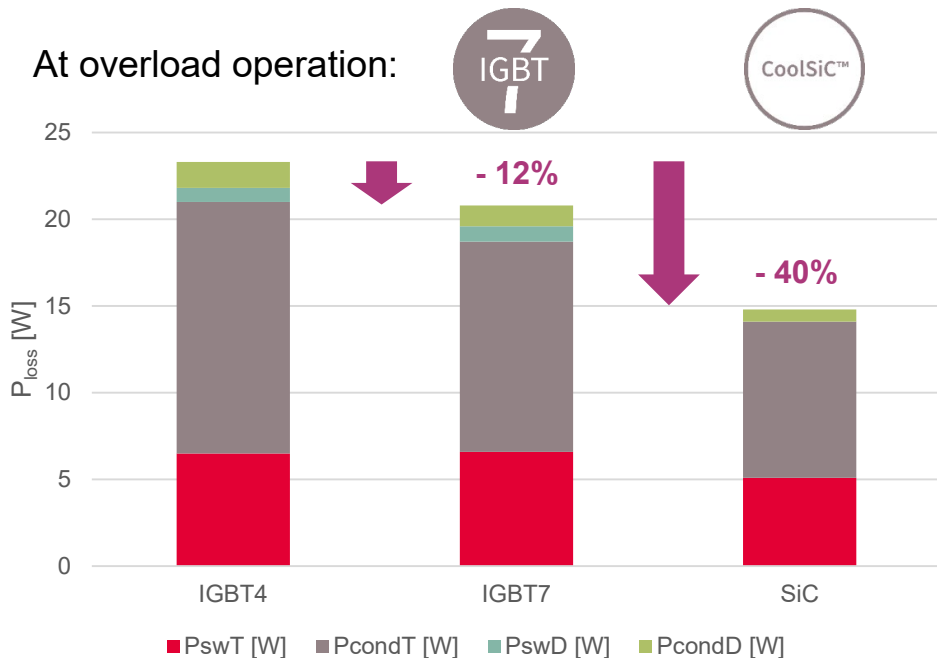
Load profiles	Overload profile
Heavy duty at 50 Hz	12.5 A (100%) / 18.75 A (150%)



Module parameters	25 A IGBT4 Easy2B	25 A IGBT7 Easy2B	45 mΩ (25 A) SiC Easy1B
$V_{CE,0}@25 \text{ A}, 125^\circ\text{C}$	2.15 V	1.75 V	1.5 V
$E_{on} + E_{off} + E_{rec} @ 25 \text{ A}, 125^\circ\text{C}$ $dv/dt_{10-90} = 5 \text{ kV}/\mu\text{s}$	290 $\mu\text{J}/\text{A}$	306 $\mu\text{J}/\text{A}$	98 $\mu\text{J}/\text{A}$
$T_{vjop,max}$	150°C	175°C	150°C

Case study: Easy package power losses – 50 Hz operation

> At overload operation:



Source: siemens.com

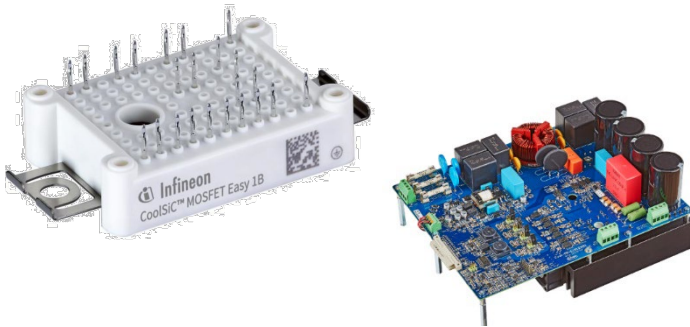
Si or SiC – which technology is the better fit for servo drives

- > SiC-MOSFET will not replace IGBT in most servo drives applications, if
 - > Sufficient power semiconductor cooling is possible
 - > Only moderate output frequencies are required $f_{out} < 800$ Hz

- > Conduction losses decrease significantly from IGBT4 technology to IGBT7.
- > With SiC a reduction in switching losses is also possible, which would allow us to operate at higher switching frequencies.

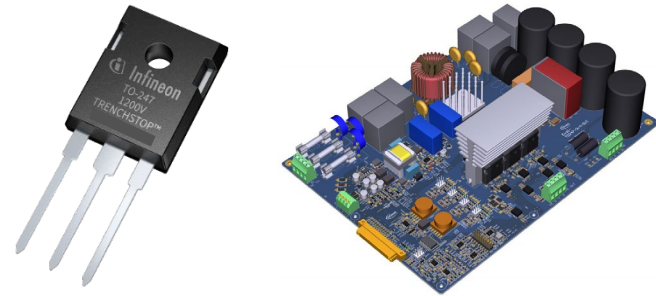
Case study of IGBTs and CoolSiC™ MOSFETs for industrial drives

- > Easy module
 - TRENCHSTOP™ IGBT4
 - TRENCHSTOP™ IGBT7
 - CoolSiC™ MOSFET
- > dv/dt selection
- > Switching losses
- > Application simulation



- > Discrete device – TO247
 - HighSpeed 3 IGBT
 - CoolSiC™ MOSFET

- > dv/dt selection
- > Switching losses
- > Application simulation
- > Application measurement

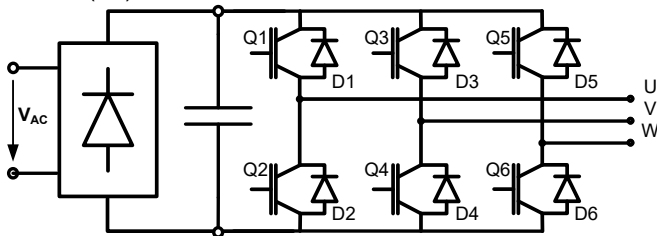


Case study: discrete device – TO247 model and parameters

- › Three-phase voltage source inverter (B6) topology was used in order to understand the behavior of servo-drives
- › Estimation of junction T_j performance and corresponding losses of the inverter for 1200 V CoolSiC™ MOSFET vs HighSpeed 3 IGBT solutions
- › The simulation study was done based on experimental test results

Test/simulation conditions

- › Simulation validation model of a three-phase voltage source inverter (B6) was used:



Based on calibration test results with following conditions:

$V_{dc} = 600 \text{ V}$, $V_{N,out} = 400 \text{ V}$, $I_{N,out} = 5 \text{ A} - 25 \text{ A}$, $f_{N,sin-out} = 50 \text{ Hz}$,

$f_{sw} = 4\text{-}16 \text{ kHz}$, $T_{amb} = 25^\circ\text{C}$, $\cos(\varphi)_N = 0.9$, $R_{th,HA} = 0.63 \text{ K/W}$, $dv/dt = 5 \text{ V/ns}$

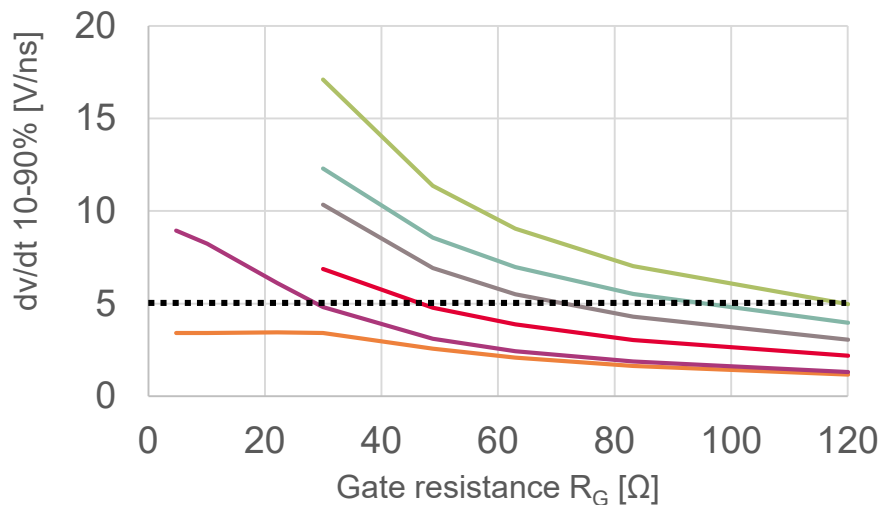
Thermal measurement of a servo-drive evaluation board



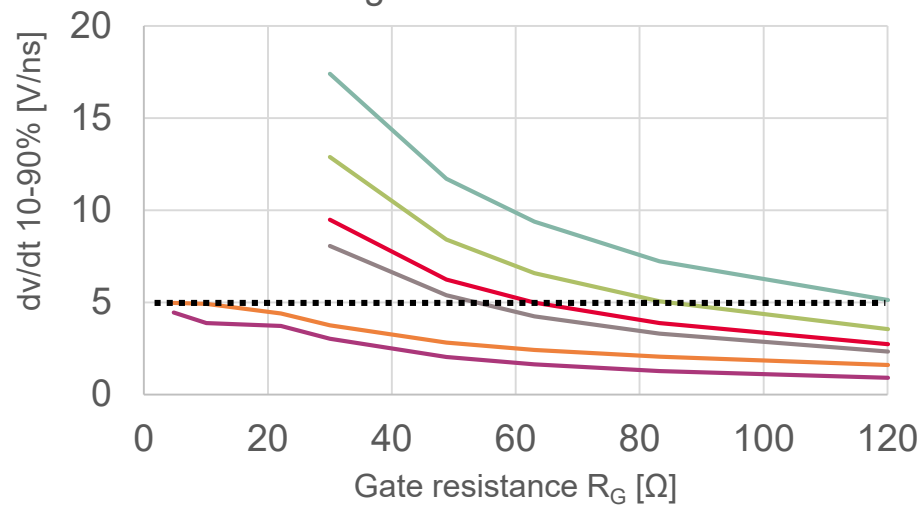
Case study: discrete device – TO247

Gate resistance R_G selection to assure < 5 V/ns

Switching current 5 A



Switching current 25 A



- Turn-OFF IMW120R030M1H — Turn-ON IMW120R030M1H
- Turn-OFF IMW120R060M1H — Turn-ON IMW120R060M1H
- Turn-OFF IKW40N120H3 — Turn-ON IKW40N120H3

- Turn-OFF IMW120R030M1H — Turn-ON IMW120R030M1H
- Turn-OFF IMW120R060M1H — Turn-ON IMW120R060M1H
- Turn-OFF IKW40N120H3 — Turn-ON IKW40N120H3

IKW40N120H3

25 A Turn OFF – **39 Ω**

5 A Turn ON – **39 Ω**



IMW120R030M1H

25 A Turn OFF – **68 Ω**

5 A Turn ON – **68 Ω**



IMW120R060M1H

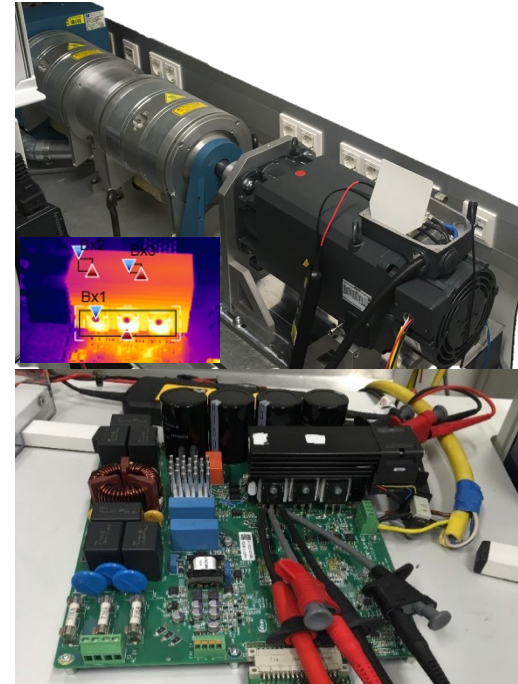
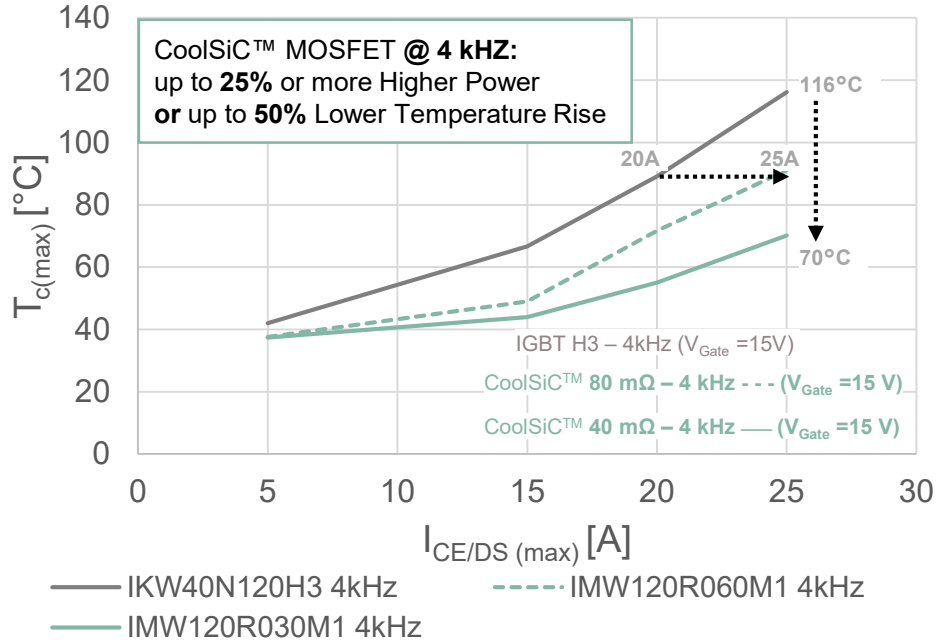
25 A Turn OFF – **120 Ω**

5 A Turn ON – **120 Ω**



What is the benefit of CoolSiC™ MOSFET at low switching frequency (4 kHz)?

Device temperatures of motor drive



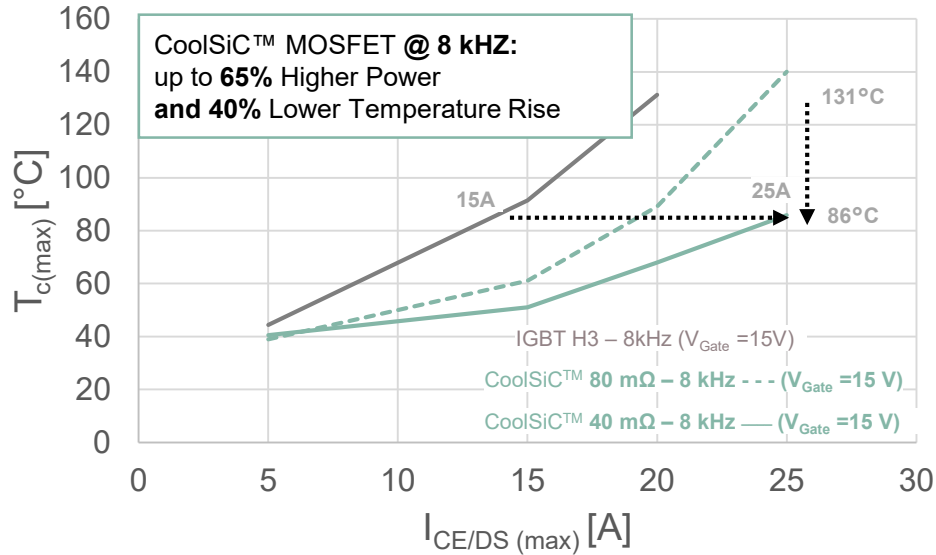
Temperature Results at 5 V/ns

The motor drive conditions

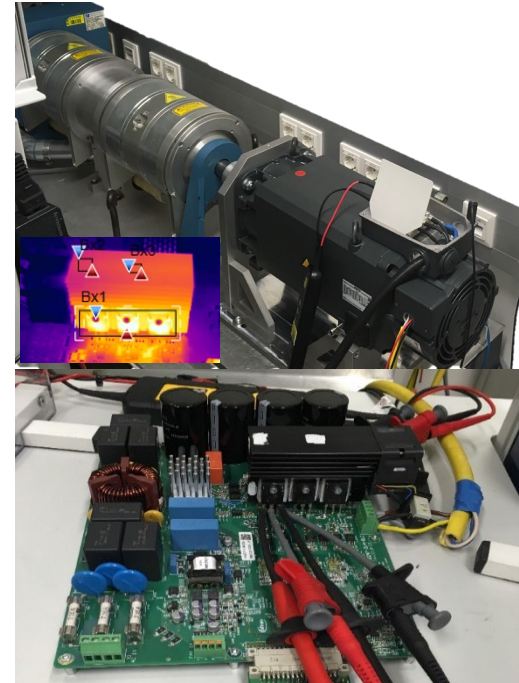
$M=1$, $V_{dc}=600V$, $f_{sin}=50Hz$, $R_G @ dv/dt=5V/ns$, $f_{sw}=4-16kHz$ with cable length (C.L.) of 5 m, $T_{amb} = 25^\circ C$

What is the benefit of CoolSiC MOSFET™ at higher switching frequency (8 kHz)?

Device temperatures of motor drive



- IMW120R060M1 8kHz
- IMW120R030M1 8kHz
- IKW40N120H3 8kHz



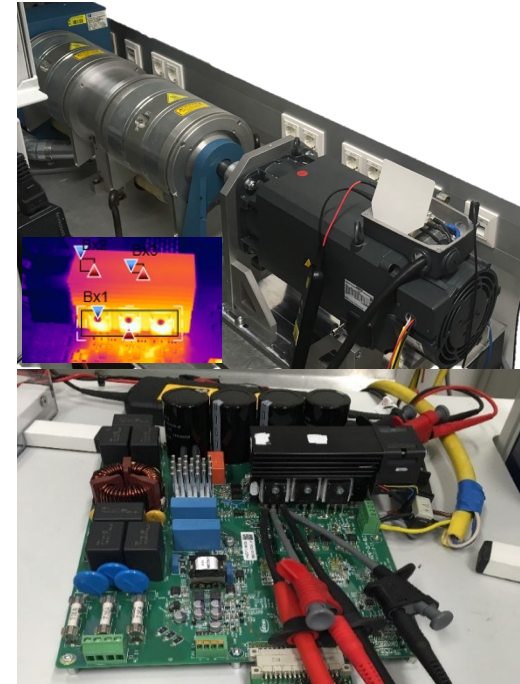
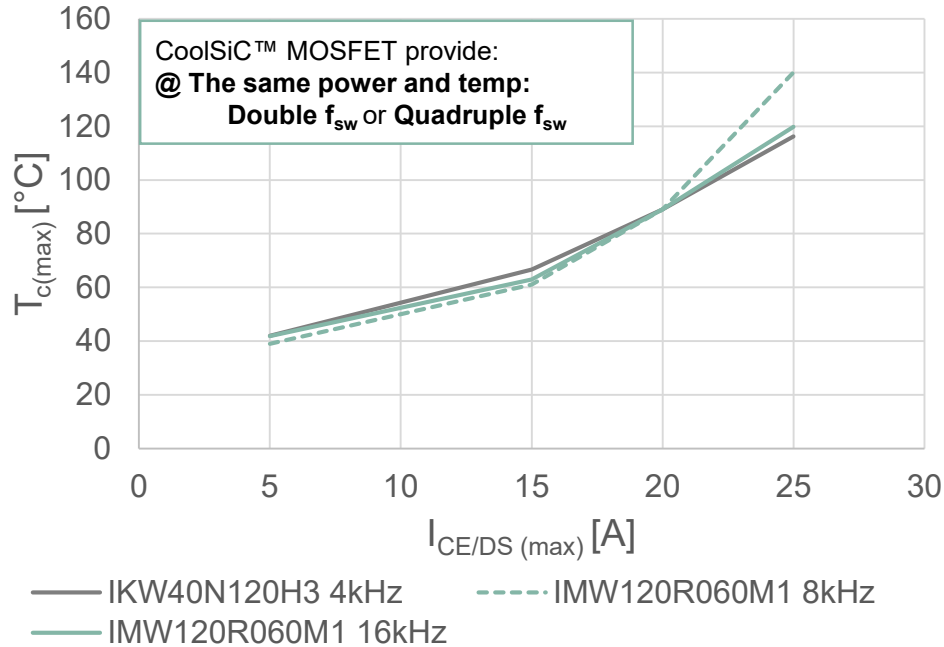
Temperature Results at 5 V/ns

The motor drive conditions

M=1, V_{dc}=600 V, f_{sin}=50 Hz, R_G @ dv/dt=5 V/ns, f_{sw}=4-16kHz with cable length (C.L.) of 5 m, T_{amb} = 25°C

What is the max f_{sw} of CoolSiC MOSFET™ at the same power and 4 kHz?

Device temperatures of motor drive

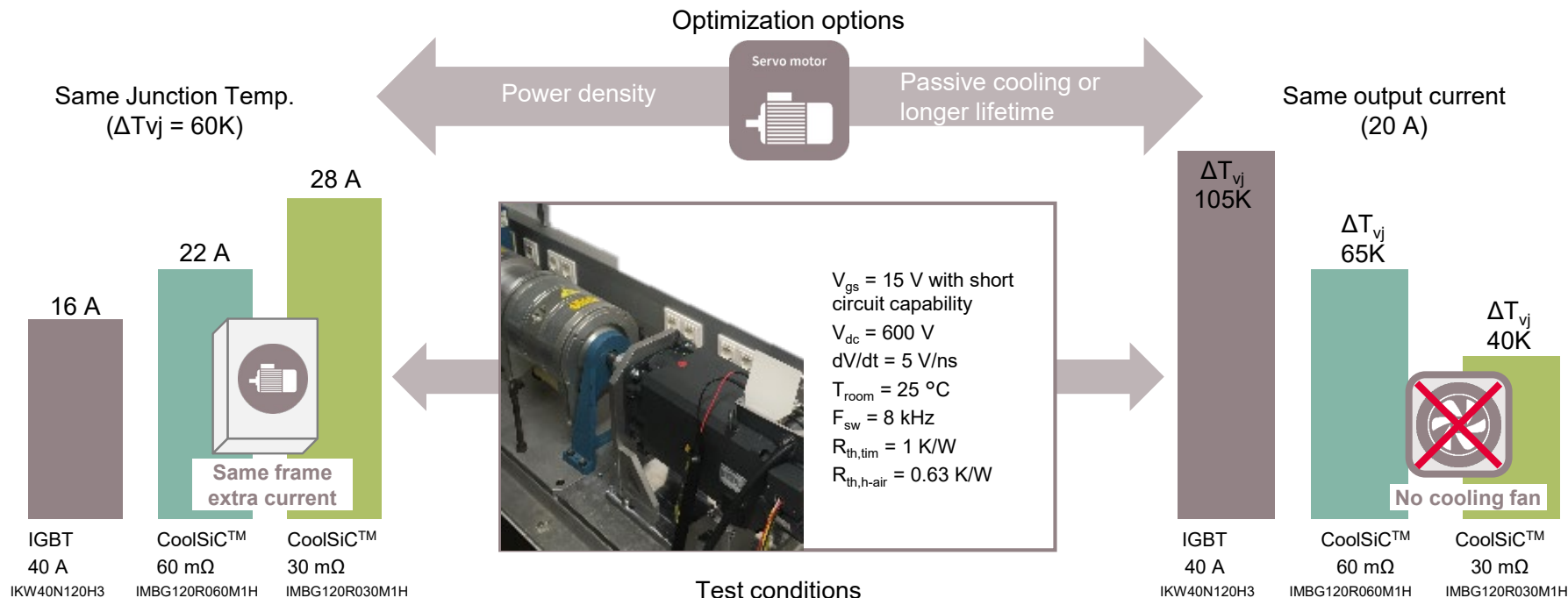


Temperature Results at 5 V/ns

The motor drive conditions

$M=1$, $V_{dc}=600$ V, $f_{sin}=50$ Hz, R_G @ $dv/dt=5$ V/ns, $f_{sw}=4-16$ kHz with cable length (C.L.) of 5 m, $T_{amb} = 25^\circ\text{C}$

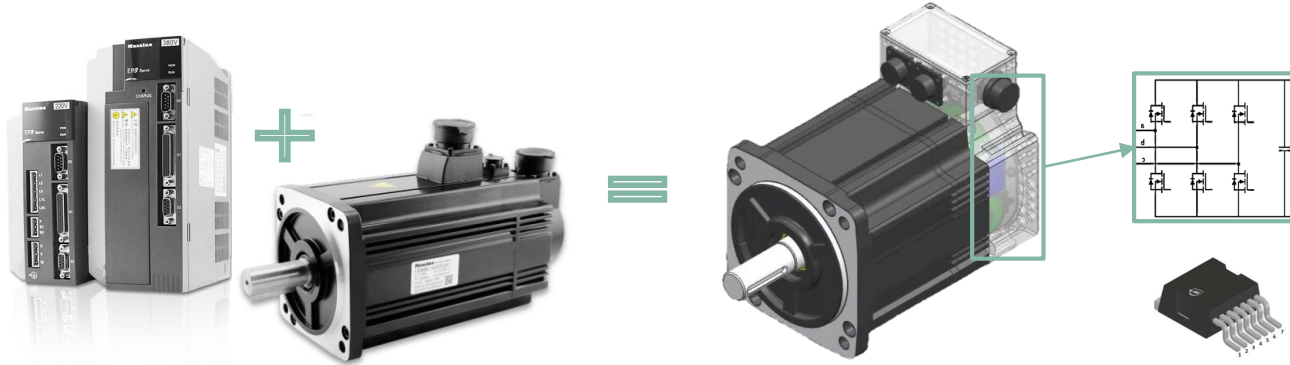
$R_{DS(on)}$ selection example for various target requirements in a servo drive solution



CoolSiC™ MOSFET enables fanless drives, higher currents for a given frame size, and more...

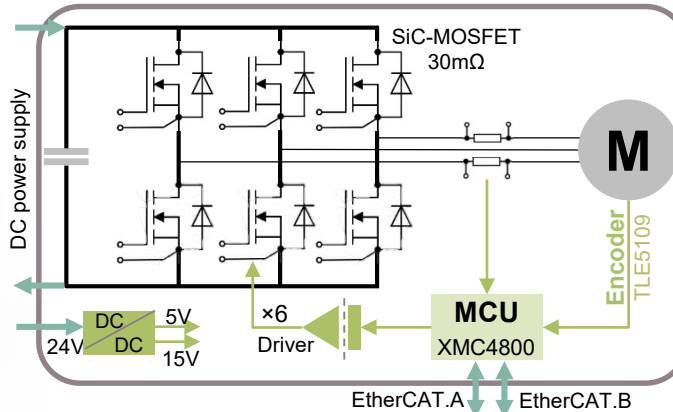
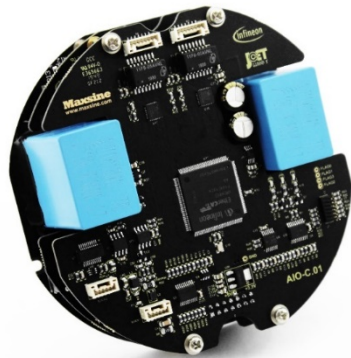


Application example with CoolSiC™ MOSFET for integrated servo motors



Infineon products:

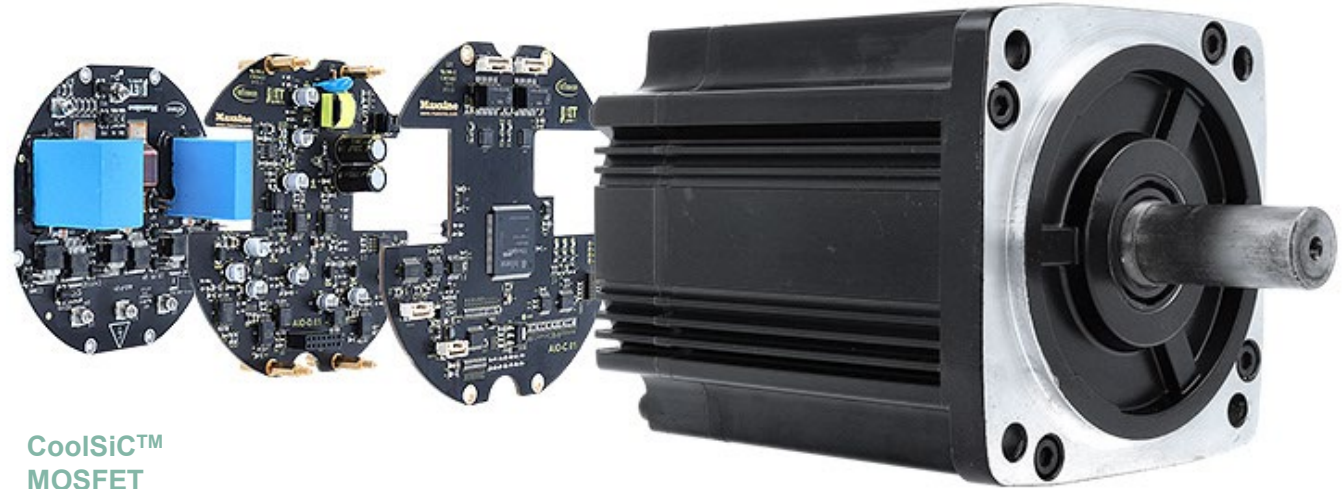
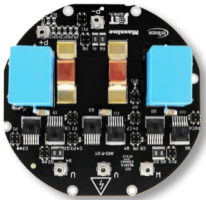
- > CoolSiC™ MOSFET
1200 V 30 mΩ
- 6 x IMBG120R030M1H
- > EiceDrivers
- 6 x 1EDI20I12MH
- > Microcontroller
- 1 x XMC™ 4800



Source: H. Weng, et al., "An integrated servo motor drive with self-cooling design by using SiC-MOSFET" *Proc. PCIM Asia*, 2020, in press

Inverter motor integration powered by Infineon products

A4 paper



CoolSiC™
MOSFET
IMBG120R030M1H

This reference design orderable in Q4 2020:

- *REF-DR3KIMBGSICMA*

Also Evaluation boards orderable in Q4 2020:

- *REF_SIC_D2pak_MC*, with Miller Clamp function
- *REF_SIC_D2pak_BP*, with bipolar power supply and separated sink/source output

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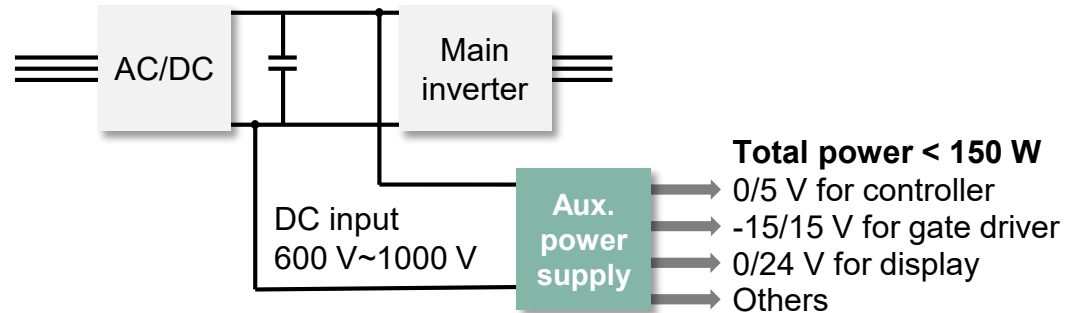
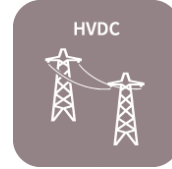
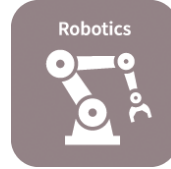
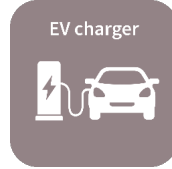
Industrial CoolSiC™ portfolio

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Key takeaways

Auxiliary power supply with 1.7 kV CoolSiC™ MOSFET

Possible applications



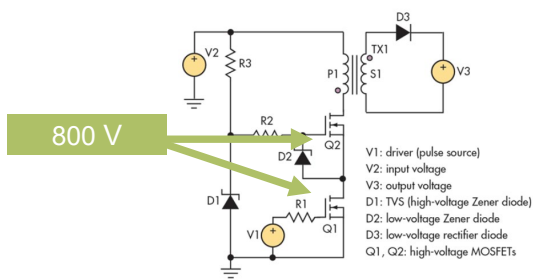
Evaluation board available



Buy online

Why 1.7 kV CoolSiC™ MOSFET?

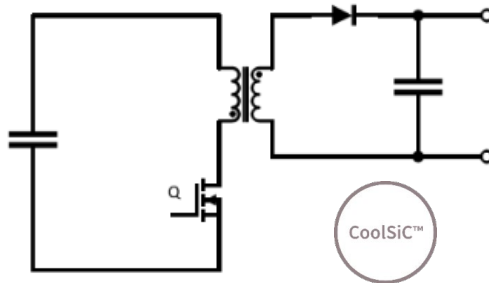
State-of-the-art solutions
(Multiple 800 V or single 1500 V Si MOSFETs)



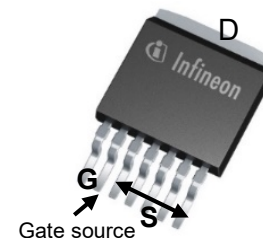
or 1500 V Si MOSFET
→ High $R_{DS(on)}$

1.7 kV CoolSiC™ MOSFET solution

Simple fly-back topology with low ohmic transistor



D²PAK 7L for 1700 V CoolSiC™ MOSFET



Perfect fitting gate voltage 0/12~15 V

Enhanced creepage and clearance distance ensure the device meets the high voltage standards with minimum design efforts

- › Comparing with multiple 800 V or single 1500 V Si MOSFET solutions:
 - Greatly reduces part counts → BoM reduction
 - Higher voltage margin and lower device count → increased reliability

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CoolSiC™ MOSFET evaluation boards

Board name	Description
EVAL-M5-IMZ120R-SIC	Motor drives inverter board with CoolSiC™ MOSFET in TO247 package
EVAL-M5-E1B1245N-SIC	CoolSiC™ MOSFET motor drives evaluation board for 7.5 kW in EasyPACK™ 1B package
EVAL-PS-E1BF12-SIC	Evaluation board for CoolSiC™ Easy1B half-bridge modules
EVAL_PS_SIC_DP_MAIN	CoolSiC™ MOSFET 1200 V in TO-247 3-/4-pin evaluation platform
REF_PS_SIC_DP1	Miller clamp function board for CoolSiC™ MOSFET 1200 V in TO-247 3-/4-pin evaluation platform
REF_PS_SIC_DP2	Bipolar supply function board for CoolSiC™ MOSFET 1200 V in TO-247 3-/4-pin evaluation platform
EVAL-1EDC20H12AH-SIC	Gate driver evaluation board with EiceDRIVER™ and CoolSiC™ MOSFET

 find more [online](#)

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CoolSiC™ MOSFET 1200 V / 1700 V discrete

TO-247

R_{dson} [mΩ]	1200 V TO-247-3
30	IMW120R030M1H
45	IMW120R045M1
60	IMW120R060M1H
90	IMW120R090M1H
140	IMW120R140M1H
220	IMW120R220M1H
350	IMW120R350M1H

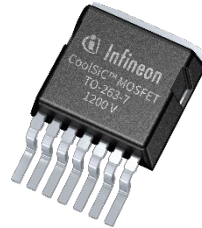


R_{dson} [mΩ]	1200 V TO-247-4
30	IMZ120R030M1H
45	IMZ120R045M1
60	IMZ120R060M1H
90	IMZ120R090M1H
140	IMZ120R140M1H
220	IMZ120R220M1H
350	IMZ120R350M1H

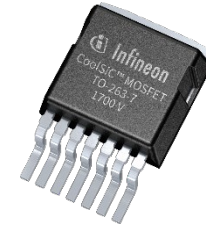


SMD

R_{dson} [mΩ]	1200 V D ² PAK-7
30	IMBG120R030M1H*
45	IMBG120R045M1H*
60	IMBG120R060M1H*
90	IMBG120R090M1H*
140	IMBG120R140M1H*
220	IMBG120R220M1H*
350	IMBG120R350M1H*



R_{dson} [mΩ]	1700 V D ² PAK-7 high creepage
450	IMBF170R450M1
650	IMBF170R650M1
1000	IMBF170R1K0M1



Orderable, registerable and available / *Samples available



Significant improvement of thermal capabilities by .XT interconnection

Standard interconnection

Standard soldering

CoolSiC™ chip

Package leadframe (Cu)

(a) SiC chip
solder
package leadframe

Standard soldering

.XT interconnection in TO-263-7

Diffusion soldering

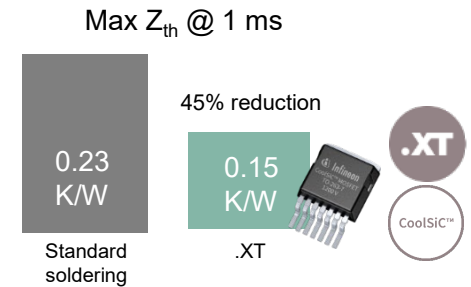
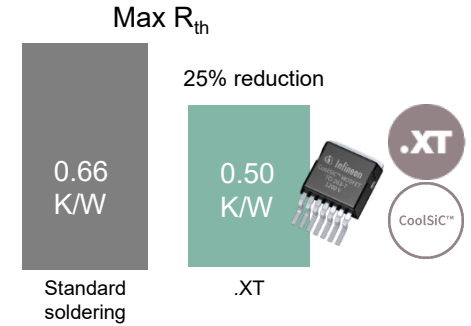
CoolSiC™ chip

Package leadframe (Cu)

(b)

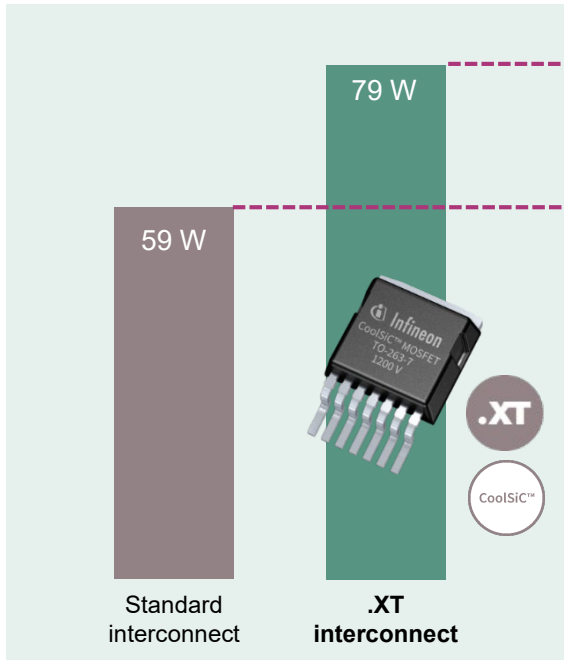
Elimination of solder joint through diffusion soldering

Thermal performance in small form factor



.XT enhances optimization potential even further for SiC based designs

Loss dissipation capability



>30% extra loss can be dissipated by .XT interconnection

Up to 14% extra current

or

Doubling f_{sw}
(2L 3-ph full bridge)

or

10 ~15°C lower temperature

Examples of application optimizations

Up to 14% extra power in given system size

Half size of passives

Up to 80% lifetime extension

Conditions:
 $T_{case} = 100^{\circ}C$;
Allowed temperature $T_{vj} = 130^{\circ}C$
CoolSiC™ MOSFET: 30 mΩ, IMBG120R030M1H

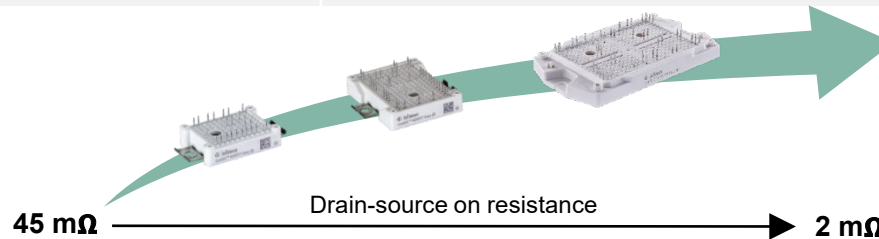
CoolSiC™ MOSFET 1200 V in EasyPACK™



R_{Dson} [mΩ]	1200 V half-bridge	1200 V SixPACK
45	FF45MR12W1M1_B11	FS45MR12W1M1_B11 <i>MADK Board</i>
23	FF23MR12W1M1(P)_B11 <i>EVAL Board</i>	
11	FF11MR12W1M1(P)_B11 FF11MR12W1M1_B70 <i>EVAL Board</i>	
8	FF8MR12W2M1(P)_B11	
6	FF6MR12W2M1(P)_B11 FF6MR12W2M1_B70	

Orderable, registerable and available now
In development

B11 = PressFIT Pin
 B70 = AlN ceramic
 P = Thermal Interface Material (TIM)
 E = common Emitter



CoolSiC™ MOSFET 1200 V in 62mm - released portfolio

On-resist. R_{DSon} [mΩ]	$I_{D nom}$ [A]	1200V	Samples	SOP plan
2	500	FF2MR12KM1	On stock	Series
3	375	FF3MR12KM1	On stock	Series
6	250	FF6MR12KM1	On stock	Series
2	500	FF2MR12KM1P	On stock	Series
3	375	FF3MR12KM1P	On stock	Series
6	250	FF6MR12KM1P	On stock	Series



Modules are available both as standard and TIM version, indication "P"

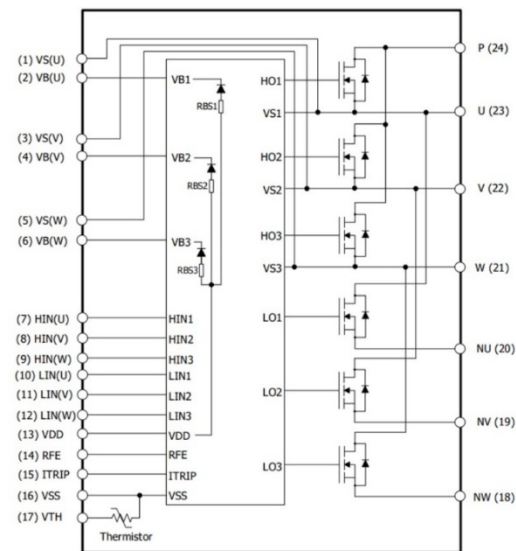
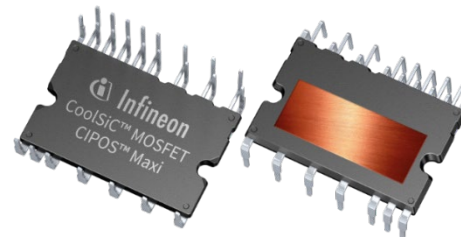


More niche application to come!

CIPOS™ Maxi 1200 V, 20 A three-phase intelligent power module

CIPOS™ Maxi 1200 V - [IM828-XCC](#)

- › Based on 1200V CoolSiC™ MOSFETs
- › Motor power rating up to 4.8 kW at 10 kHz
- › Rugged 1200 V SOI gate driver technology with stability against transient
- › Over current shutdown
- › Under-voltage lockout at all channels
- › All of 6 switches turn off during protection
- › Cross-conduction prevention
- › Built-in NTC thermistor for temperature monitor
- › Programmable fault clear timing and enable input







Challenges of driving CoolSiC™ MOSFETs

SiC MOSFET Gate Driver ICs

Infineon EiceDRIVER™ enables highest performance of SiC MOSFETs

- > **SiC MOSFETs** are **fast switching** AND high voltage devices, whose **common mode transient (CMT)** can reach **50 V/ns** or above
- > Higher switching speed requires **higher gate drive current, well-matched delays & accurate timing**
- > **SiC MOSFETs** may need a **negative gate voltage** or a **Miller clamp**
- > **SiC MOSFETs** may need **fast short circuit protection** as its short circuit capability is less than traditional IGBT

Recommended EiceDRIVER™ for 1200 V CoolSiC™ MOSFETs

Products	Part Number	Typ. Peak drive current	$V_{CC2}-V_{EE2}$	Typ. UVLO thresholds	Typ. Prop. delay	Miller-Clamp	Other key features	Package
1EDI compact isolated High-Side driver family (active & preferred)	1EDI20I12MF	4.1 A	20 V	11.9 V / 11 V	≤ 300 ns	Yes	Functional isolation	DSO-8 150 mil 
	1EDC20H12AH	3.5 A	35 V	12 V / 11.1 V	≤ 125 ns	No	8 mm Creepage clearance; UL 1577 certified with $V_{ISO} = 3 \text{ kV(rms)}$ for 1 s Miller-Clamp option	DSO-8 300 mil 
	1EDC60H12AH	9.4 A	35 V	12 V / 11.1 V	≤ 125 ns	No		
	1EDC20I12MH	4.1 A	20 V	11.9 V / 11 V	≤ 300 ns	Yes		
1ED-F2 isolated High-Side driver with integrated protection (active & preferred)	1ED020I12-F2	2.0 A	28 V	12 V / 11 V	≤ 170 ns	Yes	Short circuit clamping; DESAT protection; Active shutdown	DSO-16 
2ED-F2 isolated dual High-Side driver with integrated protection (active & preferred)	2ED020I12-F2	2.0 A	28 V	12 V / 11 V	≤ 170 ns	Yes		DSO-36 
1EDS Slew Rate Control (SRC) isolated High-Side driver (active & preferred)	1EDS20I12SV	2.0 A	28 V	11.9 V / 11 V	≤ 485 ns	Yes	Real-time adjustable gate current control; OCP; Soft turn-off shut down; Two-level turn-off; UL 1577 certified with $V_{ISO} = 5 \text{ kV(rms)}$ for 1 s	DSO-36 

Recommended EiceDRIVER™ for 1200 V CoolSiC™ MOSFETs

Products	Part number	Typ. Peak drive current	$V_{CC2}-V_{EE2}$	Typ.UVLO thresholds	Typ. Prop. delay	Miller-Clamp	Other key features	Package
1ED31xx isolated High-Side driver family	1ED3121MU12H	5.5 A	35 V	12.5 V / 10.5 V	≤ 100 ns	No	8 mm Creepage clearance; short circuit clamping; active shutdown; UL 1577 certified Miller-Clamp option	DSO-8 300 mil 
	1ED3122MU12H	10 A	35 V	10 V / 8 V	≤ 100 ns	Yes		
	1ED3124MU12H	14 A	35 V	12.5 V / 10.5 V	≤ 100 ns	No		
1ED34xx isolated High-Side driver with integrated protection	1ED3431MU12M	3 A	35 V	12.6 V / 10.4 V	≤ 255 ns	Yes	Short circuit clamping; fast & accurate DESAT protection; active shutdown, soft turn-off; UL 1577 certified	DSO-16 
	1ED3461MU12M	6 A	35 V	12.6 V / 10.4 V	≤ 255 ns	Yes*		
	1ED3491MU12M	9 A	35 V	12.6 V / 10.4 V	≤ 255 ns	Yes*		
1ED38xx isolated High-Side driver with I ² C configurability & integrated protection	1ED3830MU12M	3 A	35 V	12.6 V / 10.4 V	≤ 255 ns	Yes	Short circuit clamping; fast & accurate DESAT protection; active shutdown; soft turn-off; UL 1577 certified	DSO-16 
	1ED3860MU12M	6 A	35 V	12.6 V / 10.4 V	≤ 255 ns	Yes		
	1ED3890MU12M	9 A	35 V	12.6 V / 10.4 V	≤ 255 ns	Yes		

*Clamp driver for external MOSFET

Agenda

1

Application requirements

2

System level benefits

3

Case study of IGBTs and CoolSiC™ MOSFETs for industrial drives

4

Auxiliary power supply

5

CoolSiC™ MOSFET evaluation boards

6

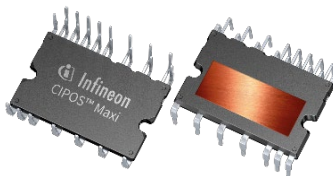
Industrial CoolSiC™ portfolio

7

Key takeaways

> **CooSiC™ IPM – CIPOS™ Maxi**

- IM828
- Compact design
- Integrated driver and protection circuit



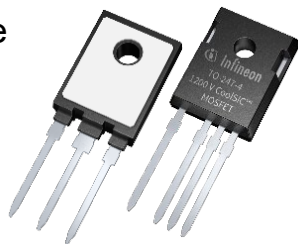
> **CoolSiC™ module – EasyPACK™**

- FS45MR12W1M1_B11
- B6 topology with NTC
- Simple mounting



> **CooSiC™ discrete – TO-247-3/4**

- IMW120R045M1
- Different $R_{DS(on)}$ values are available



> **CooSiC™ discrete – TO-263-7**

- IMBG120R030M1H
- Cooling concept via IMS
→ Good thermal performance
- Different $R_{DS(on)}$ values are available



> **Infineon EiceDRIVER™** enables highest performance of SiC MOSFETs

This makes CoolSiC™ the perfect solution for servo drives



Si or SiC – which technology is the better fit for servo drives

- › SiC-MOSFET will not replace IGBT in most servo drives applications, if
 - › Sufficient power semiconductor cooling is possible
 - › Only moderate output frequencies are required
 $f_{out} < 800 \text{ Hz}$
- › SiC-MOSFET will be used to enable compact design and to enable savings on system level, e.g. less cabling, fanless operation
- › Lower switching losses compared to IGBTs at same dv/dt level and enhanced switching control (dv/dt) is possible via gate resistor
 - Efficiency increase is feasible and reduction of cooling effort
 - Simplification of inverter integration into the motor
- › Simple and efficient auxiliary power supply design with 1.7 kV CoolSiC™ MOSFETs
- › Four different package types are available with CoolSiC™ – a unique Infineon offering: IPM, modules, through hole (TO-247) and SMD (TO-263)

Useful information material and tools

Product page links

- › [CIPOS™ IPM](#)
- › [iMOTION™](#)
- › [CoolSiC MOSFETs](#)
- › [TRENCHSTOP™ IGBT7](#)
- › [Easy power modules](#)
- › [EconoPIM™ 2 & 3](#)
- › [EconoDUAL™ IGBT modules](#)
- › [EconoPACK™ 4](#)
- › [PrimePACK™ IGBT modules](#)
- › [32-bit XMC™ microcontroller](#)
- › [ISOFACE™ digital input ICs](#)
- › [OPTIGA™ security solutions](#)
- › [Magnetic sensors](#)
- › [Current sensor](#)
- › [EiceDRIVER™ gate driver](#)
- › [External memory](#)
- › [Wireless connectivity](#)
- › [PSoC62, PSoC64](#)

Application pages

- › [Overview](#)
- › [Induction motor](#)
- › [Permanent magnet synchronized motor](#)
- › [Servo motor](#)
- › [Motor control for industrial automation](#)
- › [Robotics](#)

MADK

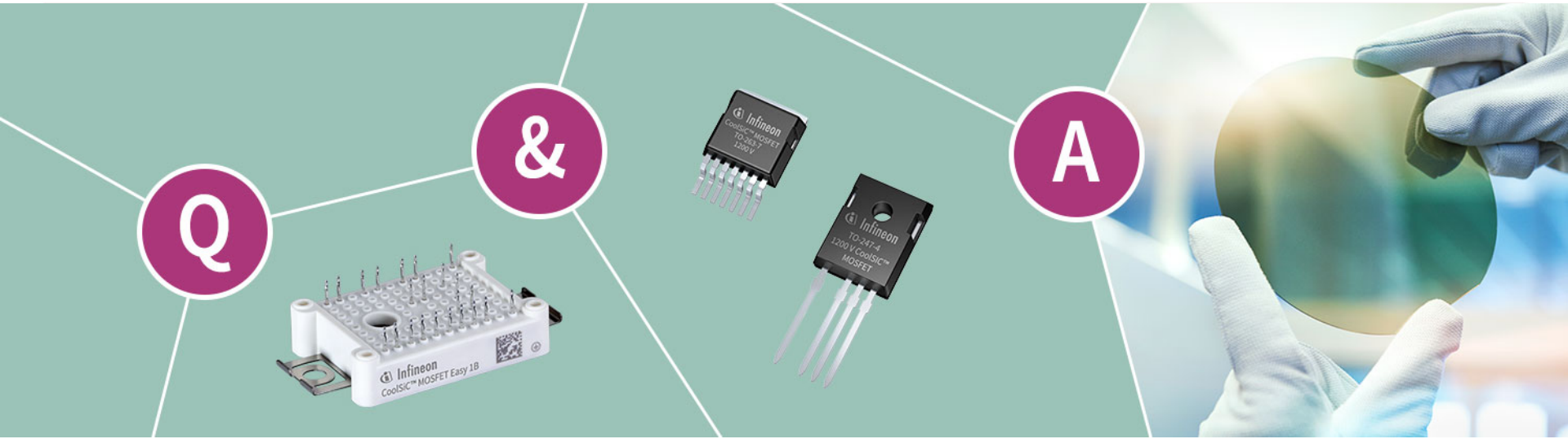
- › [iMOTION™ Modular Application Design Kit MADK](#)

Online simulations

- › [IPOSIM](#)
- › [Discrete IGBT Motor Drive Simulator](#)
- › [IPM 3-phase Inverter Simulator](#)

Online forums

- › [Silicon Carbide forum](#)
- › [IGBT modules forum](#)
- › [IGBT discretes forum](#)



We are happy to answer your questions now.

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